

ESDSRV05-4H

Features

- SOT23-6L package
- Protects four high-speed data lines and one power line
- Working voltage: 5V
- Low leakage current
- Low clamping voltage
- Response time is typically < 1ns
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 - Air discharge: $\pm 30kV$
 - Contact discharge: $\pm 30kV$
 - IEC61000-4-5 (Lightning) 20A (8/20 μs)

Description

The ESDSRV05-4H integrates low capacitance rail-to-rail diodes with an additional zener diode to protect each I/O pin against ESD and high surge events.

This robust device can safely absorb 20A surge current per IEC 61000-4-5, 2nd Edition ($t_p=8/20\mu s$) without performance degradation and a minimum $\pm 30kV$ ESD per IEC 61000-4-2. Their very low loading capacitance also makes them ideal for protecting high speed signal pins.

Applications

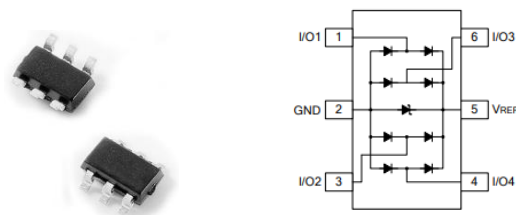
- USB 2.0 power and data line protection
- Digital video interface (DVI)
- 10/100/1000 ethernet
- SIM ports
- ATM interfaces
- Notebook computers
- Monitors and flat panel displays
- Video graphics cards

Absolute Maximum Ratings

Tamb=25°C unless otherwise specified

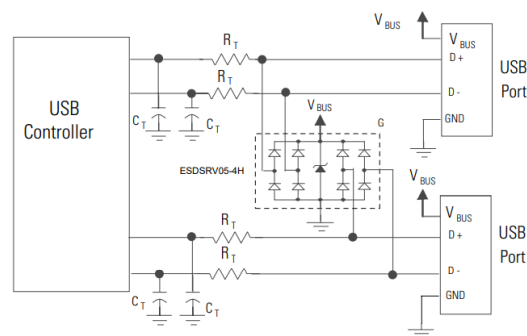
| Parameter | Symbol | Value | Unit |
|------------------------------------|--------------------|-------------|------|
| Peak Pulse Power (8/20 μs) | Ppp | 400 | W |
| Maximum Reverse Peak Pulse Current | I _{PP} *1 | 20 | A |
| ESD per IEC 61000-4-2 (Air) | V _{ESD} | ± 30 | KV |
| ESD per IEC 61000-4-2 (Contact) | | ± 30 | |
| Storage Temperature Range | T _{STJ} | -55 to +150 | °C |
| Operating Temperature Range | T _J | -55 to +125 | °C |

Circuit Diagram

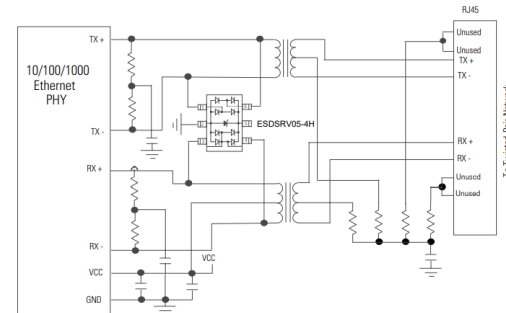


Application Examples

USB Dual Port Protection



10/100/1000 Ethernet Protection

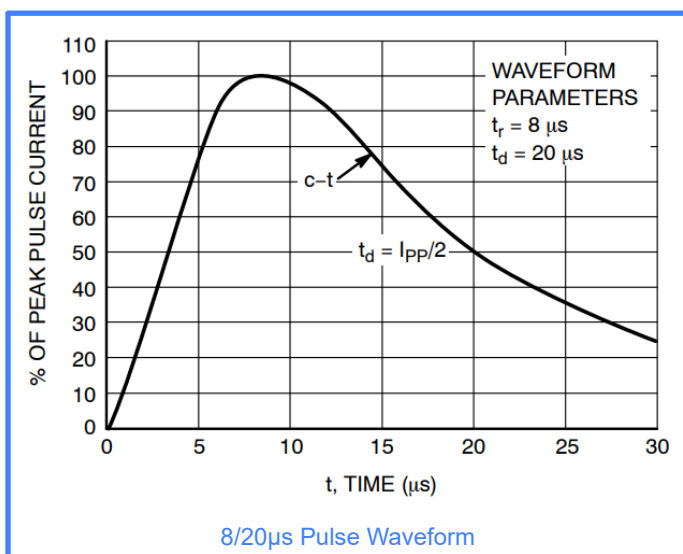
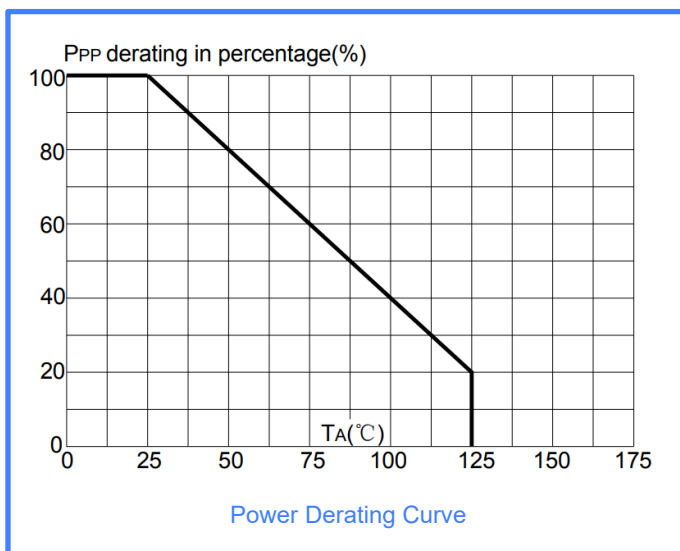
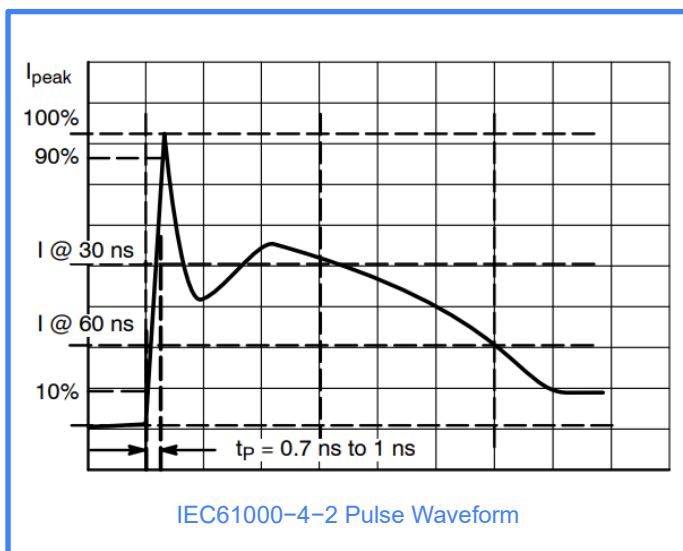


Electrical Characteristics

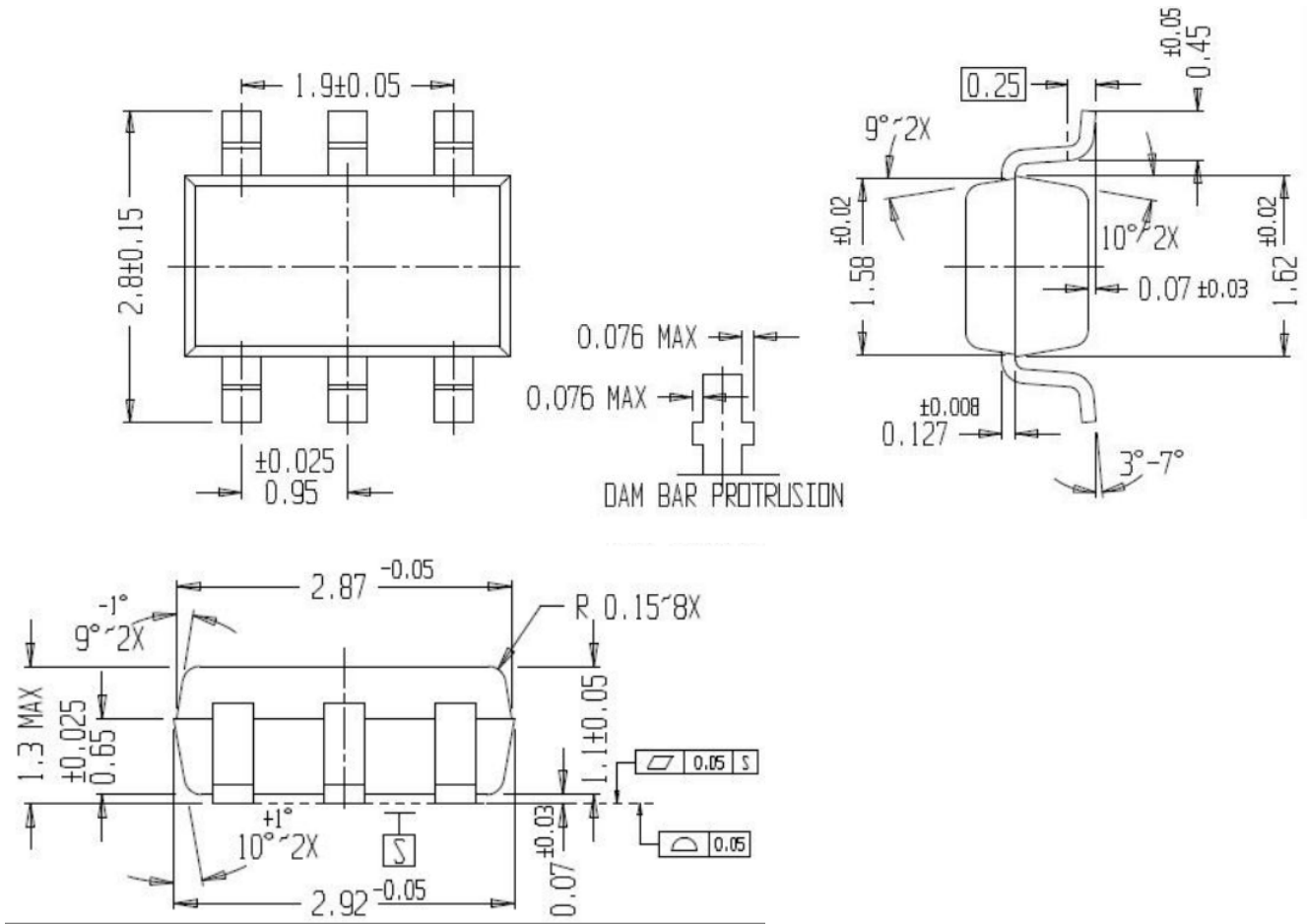
TA=25°C unless otherwise specified

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------|--------------------------------|--|-----|-----|-----|---------------|
| V_{RWM} | Reverse Standoff Voltage | I/O to GND | | | 5 | V |
| V_{BR} | Reverse Breakdown Voltage | $I_T = 1\text{mA}$, I/O to GND | 6 | | | V |
| I_R | Reverse Leakage Current | $V_{RWM} = 5\text{V}$, I/O to GND | | | 1 | μA |
| V_C | Clamping Voltage I/O to GND | $I_{PP}=20\text{A}$, $t_P = 8/20\mu\text{s}$ | | 19 | 20 | V |
| V_C | Clamping Voltage GND to I/O | $I_{PP}=20\text{A}$, $t_P = 8/20\mu\text{s}$ | | 9 | 10 | V |
| C_{J1} | Diode Capacitance | $V_R = 0\text{V}$, $f = 1\text{MHz}$, I/O to I/O | | 1.6 | 2.5 | pF |
| C_{J2} | Diode Capacitance | $V_R = 0\text{V}$, $f = 1\text{MHz}$, I/O to GND | | 3.2 | 5.0 | pF |

Characteristic Curves



SOT23-6L Dimensions(mm)



Disclaimer

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.